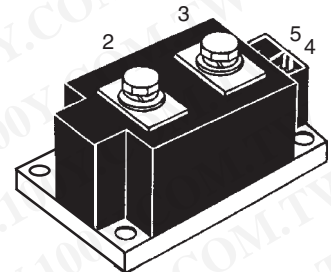
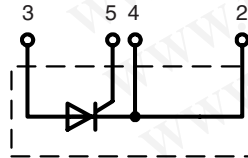


# High Power Single Thyristor Module

$I_{TRMS} = 928 \text{ A}$   
 $I_{TAV} = 600 \text{ A}$   
 $V_{RRM} = 1600-2200 \text{ V}$

$V_{RSM}$ $V_{DSM}$ V	$V_{RRM}$ $V_{DRM}$ V	Type
1700	1600	MCO 600-16io1
1900	1800	MCO 600-18io1
2100	2000	MCO 600-20io1
2300	2200	MCO 600-22io1



Symbol	Conditions	Maximum Ratings	
$I_{TRMS}$	$T_{VJ} = T_{VJM}$	928 A	
$I_{TAV}$	$T_C = 85^\circ\text{C}; 180^\circ \text{ sine}$	600 A	
$I_{TSM}$	$T_{VJ} = 45^\circ\text{C}; V_R = 0$	$t = 10 \text{ ms (50 Hz)}$	15000 A
		$t = 8.3 \text{ ms (60 Hz)}$	16000 A
$I^2t$	$T_{VJ} = T_{VJM}; V_R = 0$	$t = 10 \text{ ms (50 Hz)}$	13000 A
		$t = 8.3 \text{ ms (60 Hz)}$	14400 A
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}; f = 50\text{Hz}; I_G = 1\text{A}$	repetitive, $I_T = 960\text{A}$	100 A/ $\mu\text{s}$
		$V_D = \frac{2}{3} V_{DRM}$ $t_p = 200 \mu\text{s}$ $di_G/dt = 1 \text{ A}/\mu\text{s}$	non repetitive, $I_T = I_{TAVM}$
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}; V_{DR} = \frac{2}{3} V_{DRM}$ $R_{GK} = \infty$ ; method 1 (linear voltage rise)	1000 V/ $\mu\text{s}$	
$P_{GM}$	$T_{VJ} = T_{VJM}; I_T = I_{TAVM}$	$t_p = 30 \mu\text{s}$	120 W
		$t_p = 500 \mu\text{s}$	60 W
$P_{GAV}$		30 W	
$V_{RGM}$		10 V	
$T_{VJ}$		-40...140 °C	
$T_{VJM}$		140 °C	
$T_{stg}$		-40...125 °C	
$V_{ISOL}$	50/60 Hz, RMS; $t = 1 \text{ min}$ $I_{ISOL} \leq 1 \text{ mA}; t = 1 \text{ s}$	3000 V~	
		3600 V~	
$M_d$	Mounting torque (M6)	4.5-7/40-62 Nm/lb.in.	
	Terminal connection torque (M8)	11-13/97-115 Nm/lb.in.	
Weight	Typical including screws	650 g	

## Features

- Direct copper bonded  $\text{Al}_2\text{O}_3$ -ceramic with copper base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL applied
- Keyed gate/cathode twin pins

## Applications

- Motor control, softstarter
- Power converter
- Heat and temperature control for industrial furnaces and chemical processes
- Lighting control
- Solid state switches

## Advantages

- Improved temperature and power cycling
- Reduced protection circuits

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

IXYS reserves the right to change limits, test conditions and dimensions

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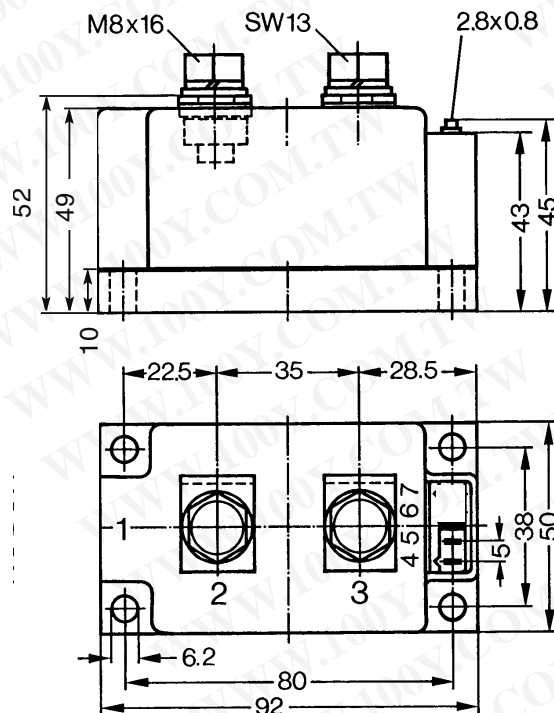
Symbol	Conditions	Characteristic Values
$I_{RRM}$	$T_{VJ} = T_{VJM}; V_R = V_{RRM}$	60 mA
$V_T$	$I_T = 600 \text{ A}; T_{VJ} = 25^\circ\text{C}$	1.15 V
$V_{T0}$	For power-loss calculations only ( $T_{VJ} = T_{VJM}$ )	0.77 V
$r_T$		0.42 mΩ
$V_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$	2 V
	$T_{VJ} = -40^\circ\text{C}$	3 V
$I_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$	300 mA
	$T_{VJ} = -40^\circ\text{C}$	400 mA
$V_{GD}$	$T_{VJ} = T_{VJM}; V_D = \frac{2}{3} V_{DRM}$	0.25 V
$I_{GD}$	$T_{VJ} = T_{VJM}; V_D = \frac{2}{3} V_{DRM}$	10 mA
$I_L$	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; t_p = 30 \mu\text{s}$ $di_G/dt = 1 \text{ A}/\mu\text{s}; I_G = 1 \text{ A}$	400 mA
$I_H$	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$	300 mA
$t_{gd}$	$T_{VJ} = 25^\circ\text{C}; V_D = \frac{1}{2} V_{DRM}$ $di_G/dt = 1 \text{ A}/\mu\text{s}; I_G = 1 \text{ A}$	2 μs
$t_q$	$T_{VJ} = T_{VJM}; V_R = 100 \text{ V}; V_D = \frac{2}{3} V_{DRM}; t_p = 200 \mu\text{s}$ $dv/dt = 50 \text{ V}/\mu\text{s}; I_T = 500 \text{ A}; -di/dt = 10 \text{ A}/\mu\text{s}$	typ. 350 μs
$R_{thJC}$	DC current	0.065 K/W
$R_{thJK}$	DC current	0.085 K/W
$d_s$	Creep distance on surface	12.7 mm
$d_A$	Strike distance in air	9.6 mm
$a$	Maximum allowable acceleration	50 m/s <sup>2</sup>

Optional accessories for modules

Keyed Gate/Cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

Type **ZY 180 L** (L = Left for pin pair 4/5) { UL 758, style 1385, File E 38136,  
CSA class 5851, guide 460-1-1, appl. 41234

Dimensions in mm (1 mm = 0.0394")



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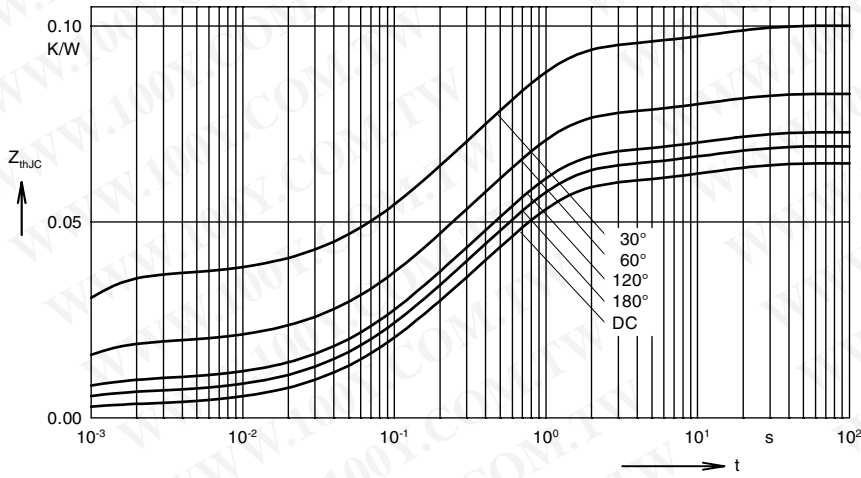


Fig. 1 Transient thermal impedance junction to case (per thyristor)

$R_{thJC}$  for various conduction angles d:

d	$R_{thJC}$ (K/W)
DC	0.065
180°	0.069
120°	0.073
60°	0.083
30°	0.1

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0031	0.00054
2	0.0168	0.098
3	0.039	0.54
4	0.0061	12

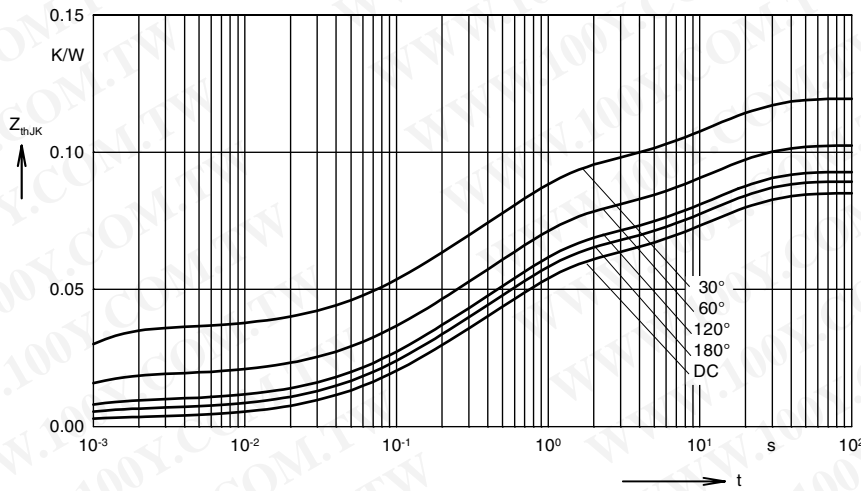


Fig. 2 Transient thermal impedance junction to heatsink (per thyristor)

$R_{thJK}$  for various conduction angles d:

d	$R_{thJK}$ (K/W)
DC	0.085
180°	0.089
120°	0.093
60°	0.102
30°	0.119

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0031	0.00054
2	0.0168	0.098
3	0.039	0.54
4	0.0061	12
5	0.02	12